



## Small Signal MOSFET Transistor

**2SK3019**

### FEATURES

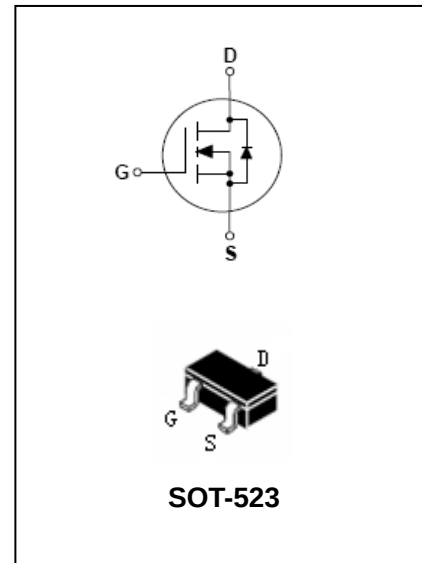
- Low on-resistance.
- Low voltage drive(2.5v)makes this device  
Ideal for portable equipment.
- Easily designed drive circuits.
- Fast switching speed.
- Easy to parallel.
- GS ESD 1000V



Lead-free

### APPLICATIONS

- N-channel MOSFET.
- Interfacing, switching (30V, 100mA).



### ORDERING INFORMATION

| Type No. | Marking | Package Code |
|----------|---------|--------------|
| 2SK3019  | KN      | SOT-523      |

### MAXIMUM RATING @ Ta=25°C unless otherwise specified

| Symbol           | Parameter                                       | Value       | Units |
|------------------|-------------------------------------------------|-------------|-------|
| V <sub>DSS</sub> | Drain-Source voltage                            | 30          | V     |
| V <sub>GSS</sub> | Gate -Source voltage                            | ± 20        | V     |
| I <sub>D</sub>   | Drain current<br>-continuous<br>-Pulsed         | 100<br>200  | mA    |
| I <sub>DR</sub>  | Reverse Drain current<br>-continuous<br>-Pulsed | 100<br>200  | mA    |
| P <sub>D</sub>   | Power Dissipation                               | 150         | mW    |
| T <sub>ch</sub>  | Channel temperature                             | 150         | °C    |
| T <sub>stg</sub> | Storage Temperature                             | -55 to +150 | °C    |



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### ELECTRICAL CHARACTERISTICS @ Ta=25°C unless otherwise specified

| Parameter                                 | Symbol        | Test conditions                                                           | MIN | TYP    | MAX     | UNIT     |
|-------------------------------------------|---------------|---------------------------------------------------------------------------|-----|--------|---------|----------|
| Drain-Source Breakdown Voltage            | $V_{(BR)DSS}$ | $V_{GS}=0V, I_D=10\mu A$                                                  | 30  |        |         | V        |
| Gate Threshold Voltage                    | $V_{GS(th)}$  | $V_{DS}=3V, I_D=-100\mu A$                                                | 0.8 |        | 1.5     |          |
| Gate-body Leakage      Forward<br>Reverse | $I_{GSS}$     | $V_{DS}=0V, V_{GS}=20V$<br>$V_{DS}=0V, V_{GS}=-20V$                       |     |        | 1<br>-1 | $\mu A$  |
| Zero Gate Voltage Drain Current           | $I_{DSS}$     | $V_{DS}=30V, V_{GS}=0V$                                                   |     |        | 1.0     | $\mu A$  |
| Static drain-Source on-state resistance   | $R_{DS(ON)}$  | $V_{GS}=4V, I_D=10mA$<br>$V_{GS}=2.5V, I_D=1mA$                           |     | 5<br>7 | 8<br>13 | $\Omega$ |
| Forward transfer admittance               | $ Y_{fs} $    | $I_D=10mA, V_{DS}=3V$                                                     | 20  |        |         | ms       |
| Input capacitance                         | $C_{ISS}$     | $V_{DS}=5V, V_{GS}=0V, f=1.0MHz$                                          |     | 13     |         | pF       |
| Output capacitance                        | $C_{OSS}$     |                                                                           |     | 9      |         |          |
| Reverse transfer capacitance              | $C_{RSS}$     |                                                                           |     | 4      |         |          |
| Turn-On Delay Time                        | $t_{D(ON)}$   | $V_{DD}=5V, I_D=10mA$<br>$R_L=500\Omega, V_{GS}=5V,$<br>$R_{GS}=10\Omega$ |     | 15     |         | ns       |
| Rise time                                 | $t_r$         |                                                                           |     | 35     |         | ns       |
| Turn-Off Delay Time                       | $t_{D(OFF)}$  |                                                                           |     | 80     |         | ns       |
| Fall time                                 | $t_f$         |                                                                           |     | 80     |         | ns       |

### TYPICAL CHARACTERISTICS @ Ta=25°C unless otherwise specified

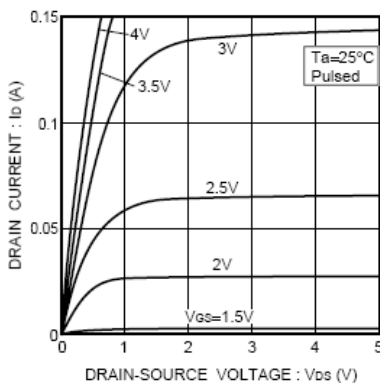


Fig.1 Typical output characteristics

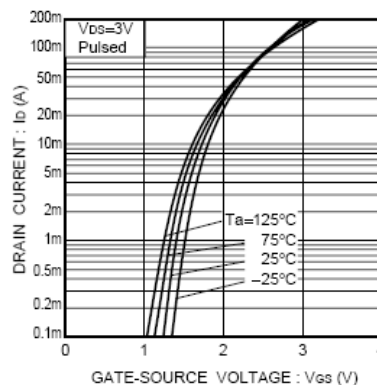


Fig.2 Typical transfer characteristics

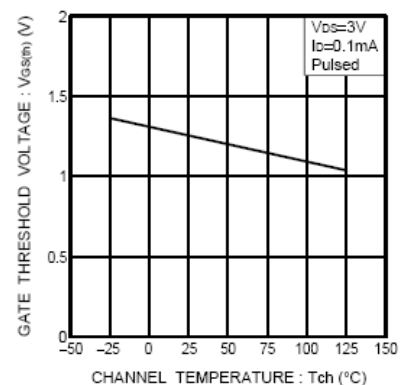


Fig.3 Gate threshold voltage vs. channel temperature

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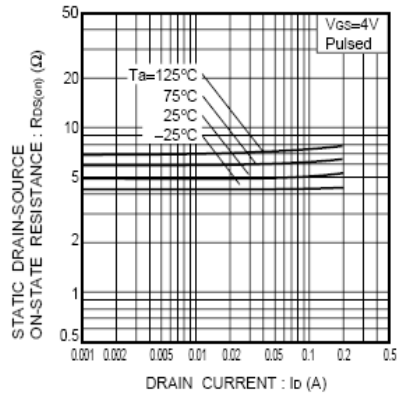


Fig.4 Static drain-source on-state resistance vs. drain current (I)

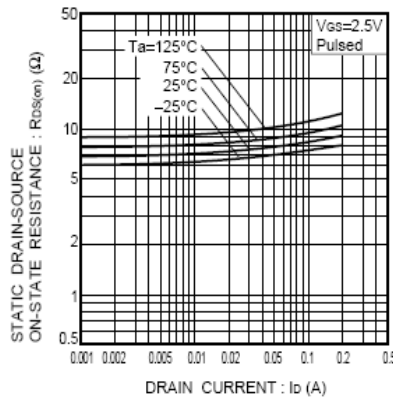


Fig.5 Static drain-source on-state resistance vs. drain current (II)

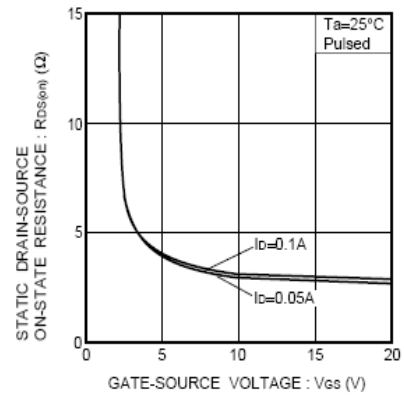


Fig.6 Static drain-source on-state resistance vs. gate-source voltage

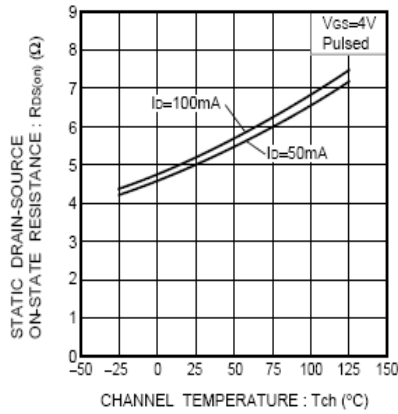


Fig.7 Static drain-source on-state resistance vs. channel temperature

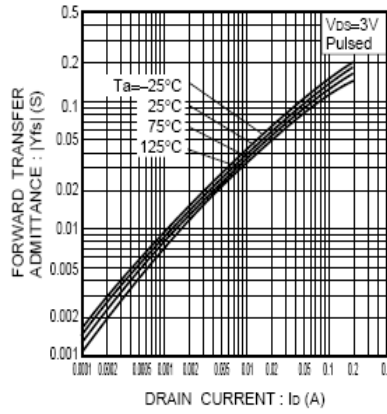


Fig.8 Forward transfer admittance vs. drain current

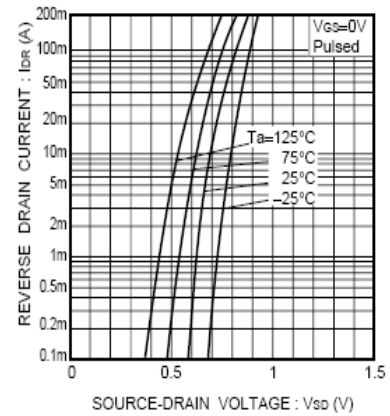


Fig.9 Reverse drain current vs. source-drain voltage (I)

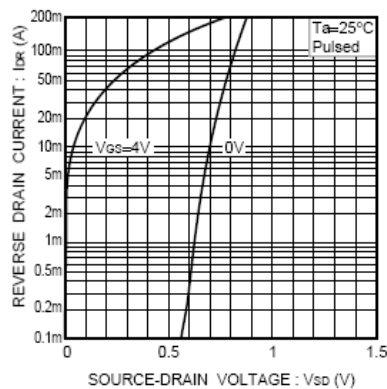


Fig.10 Reverse drain current vs. source-drain voltage (II)

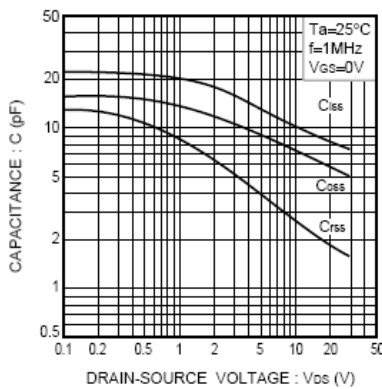


Fig.11 Typical capacitance vs. drain-source voltage

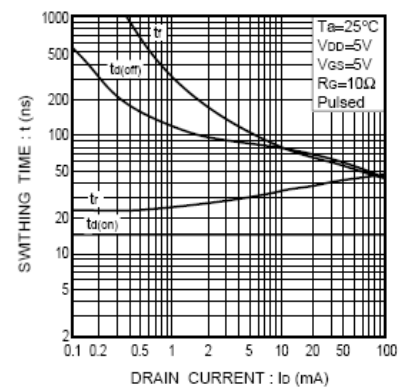


Fig.12 Switching characteristics (See Figures 13 and 14 for the measurement circuit and resultant waveforms)



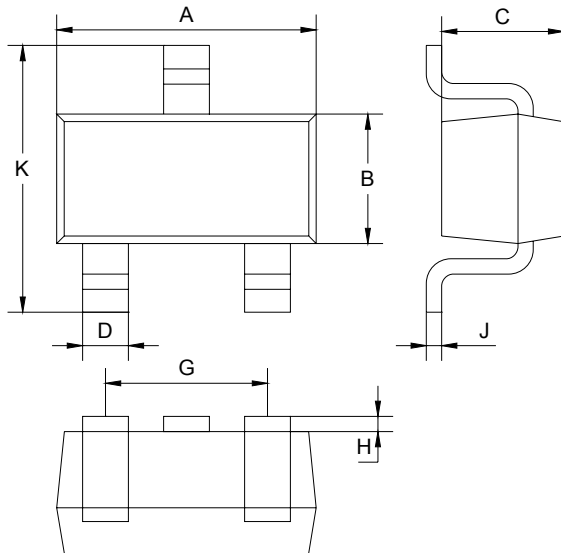
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### PACKAGE OUTLINE

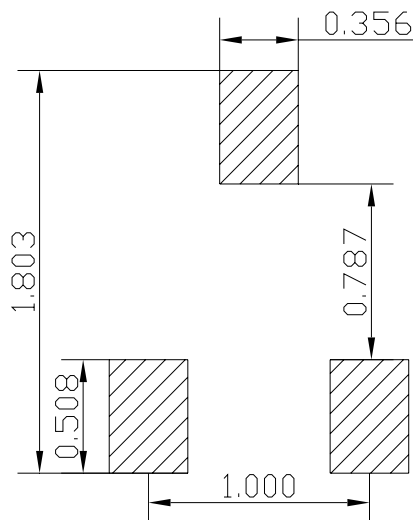
Plastic surface mounted package

SOT-523



| SOT-523              |            |      |
|----------------------|------------|------|
| Dim                  | Min        | Max  |
| A                    | 1.5        | 1.7  |
| B                    | 0.75       | 0.85 |
| C                    | 0.6        | 0.8  |
| D                    | 0.15       | 0.3  |
| G                    | 0.9        | 1.1  |
| H                    | 0.02       | 0.1  |
| J                    | 0.1Typical |      |
| K                    | 1.45       | 1.75 |
| All Dimensions in mm |            |      |

### SOLDERING FOOTPRINT



Unit : mm

### PACKAGE INFORMATION

| Device  | Package | Shipping       |
|---------|---------|----------------|
| 2SK3019 | SOT-523 | 3000/Tape&Reel |